



# ICMA 2019 IEEE International Conference on Mechatronics and Automation

August 4-7, 2019  
Tian jin, China



IEEE Robotics and Automation Society



## Registration Form

### I. Personal Information

Paper ID Number (if Author): \_\_\_\_\_ / \_\_\_\_\_ / \_\_\_\_\_ Family Name: \_\_\_\_\_ Given Name: \_\_\_\_\_

Title:  Prof.  Dr.  Mr.  Ms. Affiliation: \_\_\_\_\_

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### II. Registration Fees: Covering one CD-ROM proceedings and all social events.

	Items	Advance Registration by July 20, 2019	Registration After July 20, 2019	Payment Choices
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B	Non-Member Registration:	RMB ¥4600 (US\$700 or JP¥80000)	RMB ¥ 5000 (US\$750 or JP¥85000)	
C	IEEE Student Registration: IEEE Life Member:	RMB ¥3600 (US\$550 or JP¥60000)	RMB ¥ 3900 (US\$600 or JP¥65000)	
D	Extra Page Charge:	No. of extra pages beyond 6 pages per paper ___xRMB¥700(US\$150 or JP¥15000) =		
E	Extra Paper Charge:	No. of extra papers beyond one paper ___x RMB¥3100(US\$450 or JP¥55000) =		
F	Hard Copy of Proceedings:	No. of hard copy of proceedings _____x RMB¥1500(US\$250 or JP¥25000) =		
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H	Extra Banquet Ticket:	No. of extra banquet tickets _____ x RMB¥500(US\$100 or JP¥10000) =		
<b>Total registration payment amount (A or B or C) + D + E + F + G + H =</b>				

### III. Payment Options: The total payment calculated in item II above can be made in one of the following three methods:

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**3. Money Transfer Payment in JPY, US\$ or Euro€ (For author from Out of Japan, the Additional Handling Charge(JP¥5500/US\$50 or Euro€45) from the bank should be paid by author, which means Total Money Transfer Payment Amount should be added on JP¥5500/US\$50 or Euro€45) from outside of the Mainland China:** Please add the total application payments in US dollars or Euro € and make transfer payment to THE HYAKUJUSHI BANK, LTD (百十四銀行) (Swift Code: HYAKJPJT), Nishi Branch 西支店 (Branch No.204) with Account Number 口座番号: 0854597 and Account Holder: IEEE ICMA 2019 SHUXIANG GUO (Address: 1-24-47 Ougimachi, Takamatsu, Kagawa, Japan). Please indicate 1st author name and paper number(s).

### IV. Important Information:

- ✓ Each accepted final paper **must** be accompanied with a paid registration for inclusion in the ICMA2019 conference proceedings.
- ✓ Each paid registration (A, B or C above) covers only **one paper; you can pay** Extra Paper Charges for one more paper from the same first author who has a paid registration.
- ✓ Each student registration allows **only one paper**, and **must** be accompanied by proof of full-time, currently-registered student status via student ID or a school formal letter.
- ✓ Competed registration with payment or payment proof from inside the Mainland China **must** be sent **by E-mail** to (国内作者的注册和付款或付款证明请电邮至): 天津理工大学 IEEE ICMA 2019 会务组. 电子邮件: icma@tjut.edu.cn. 联系电话: (+86) 15102231710(郭健);
- ✓ Competed registration with payment or payment proof from outside the Mainland China **must** be sent **by Fax or Email** to: Prof. Shuxiang Guo, Faculty of Engineering, Kagawa University, 2217-20, Hayashi-cho, Takamatsu, 761-0396, Japan. Tel: +81-87-864-2333; Fax: +81-87-864-2369; E-mail: registrationforicma@eng.kagawa-u.ac.jp.